



## SPONSORSHIP FORM for SMACD2023

**SMACD 2023 – International Conference on Synthesis, Modeling, Analysis and Simulation Methods and Applications to Circuit Design**  
**3-5 July, Funchal, Madeira Island, Portugal**

The 2023 edition of the International Conference on Synthesis, Modeling, Analysis and Simulation Methods and Applications to Circuit Design (SMACD) will be held at VidaMar Resort Hotel, a stunning location on Madeira island, Portugal. SMACD is a forum devoted to modeling, simulation, and synthesis for Analog, Mixed-signal, RF (AMS/RF), and multi-domain (nanoelectronics, biological, MEMS, optoelectronics, etc.) integrated circuits and systems. Open-source tools and methods for AMS/RF and multi-domain IC design and experiences with modeling, simulation, and synthesis techniques in diverse application areas are also welcomed. Objective technologies include CMOS, beyond CMOS, and More-than-Moore such as MEMs, power devices, sensors, passives, etc. SMACD is technically co-sponsored by the **IEEE**, **IEEE CEDA** and **IEEE CASS**, and its proceedings will be published in **IEEEExplore**.

The SMACD 2023 organization makes available **4 sponsor packages**, respectively, **Diamond** (exclusive to 3 sponsors), **Platinum**, **Gold** and **Silver**. The 4 sponsor packages include different company involvement in the conference program, conference committees, conference awards, conference social events and exhibition space, please check the table below.

### Conference Program:

- Propose a Keynote Lecture (60')
- Propose a Tutorial (90')
- Pitch on the Industrial Session (10')

### Conference Awards:

- EDA Award
- IC Design Award
- Best Paper Award

### Company Logo on:

- USB for the Proceedings (provided by the company), Signs at the Gala Dinner, Acknowledgments by Conference Chair (ULTRA)
- Signs at Welcome Cocktail + Acknowledgments by Conference Chair (MAX)
- Banner at Conference Venue (PRO)
- Website, Final Program, Proceedings, Acknowledgment Slide during Session Breaks (BASIC)

### Conference Committee:

- Propose 1 to 2 TPC Members

### Exhibition Space:

- Table & Chairs, Basic Electricity, Wi-Fi
- 2 to 4 Full Registrations (FR)
- 2 to 4 3-day Accommodation (AC) at the 5\* VidaMar Resort Hotel and Congress Centre

| SPONSORSHIP LEVELS | COMPANY LOGO |     |     |       | 1-page AD<br>FINAL PROGRAM | CONFERENCE PROGRAM |          |         | CONFERENCE COMMITTEES | CONFERENCE AWARDS |             |       | EXHIBITION SPACE, REGISTRATION and ACCOMMODATION |         |   | ATTEND. KIT | SPONSOR FEE |
|--------------------|--------------|-----|-----|-------|----------------------------|--------------------|----------|---------|-----------------------|-------------------|-------------|-------|--|---------|---|-------------|-------------|
|                    | BASIC        | PRO | MAX | ULTRA |                            | Present.           | Tutorial | Keynote | TPC member            | Best Paper        | EDA and ICD | BASIC | PRO  | MAX     |   |             |             |
| DIAMOND            | ✓            | ✓   | ✓   | ✓     | ✓                          | 10'                | 90'      | 60'     | 2                     | ✓                 | Both        |       |  | 4 FR+AC | ✓ | 10,000 €    |             |
| PLATINUM           | ✓            | ✓   | ✓   |       |                            | 10'                | 90'      |         | 1                     | ✓                 | One         |       | 2 FR+AC  |         | ✓ | 6,000 €     |             |
| GOLD               | ✓            | ✓   |     |       |                            | 10'                |          |         |                       | ✓                 |             | 2 FR  |  |         | ✓ | 4,000 €     |             |
| SILVER             | ✓            |     |     |       |                            |                    |          |         |                       |                   |             |       |  |         | ✓ | 1,500 €     |             |

### General Chair:

### Industrial Liaison Co-Chairs:

Nuno Horta, IT and University of Lisbon, PT

Fábio Passos, IT, PT

Rafael Castro-López, IMSE-CNM, ES

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# SPONSORSHIP FORM for SMACD2023

Your sponsoring efforts make a significant contribution to keeping the conference fees at an acceptable level. To finalize the fee structure in sufficient time before the start of registration, your binding confirmation on your sponsorship contribution would be very helpful until 1 February 2023.

Please complete the following form for submission:

|   |                          |                          |                          |                          |
|---|--------------------------|--------------------------|--------------------------|--------------------------|
| <b>Sponsorship Packages:</b>              | Diamond                  | Platinum                 | Gold                     | Silver                   |
| <b>Sponsorship Fee (including taxes):</b> | 10000€                   | 6000€                    | 4000€                    | 1500€                    |
| <b>Sponsorship Package Selection:</b>     | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> | <input type="checkbox"/> |

|                                     |   |
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| Company:                            | With your signature, you grant us the free and non-exclusive right to use your logos, images and text materials provided by you for all publications within the scope of your sponsoring package for the SMACD2023 conference.  |
| VAT ID:                             |   |
| Contact Person:                     | <b>Please send this form filled and signed to:</b><br>Angélica Ruivo<br>Congress Coordinator, Abreu Events, Portugal<br>Phone: +351 21 415 6125<br>Email: <a href="mailto:angelica.ruivo@abreu.pt">angelica.ruivo@abreu.pt</a>  |
| Address:                            |   |
| Billing address (if different)      |   |
| Phone:                              | <b>Please send a copy to the Industrial Liaison Co-Chairs:</b><br>Fábio Passos, <i>IT, PT</i><br>Email: <a href="mailto:fabio.passos@lx.it.pt">fabio.passos@lx.it.pt</a><br>Rafael Castro-López, <i>IMSE-CNM, ES</i><br>Email: <a href="mailto:rafael.castro@csic.es">rafael.castro@csic.es</a> |
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**SMACD would like to thank you for your support to the 2023 edition!**